

MRF5S19090LR3 and MRF5S19090LSR3 replaced by MRF5S19090HR3 and MRF5S19090HSR3. "H" suffix indicates lower thermal resistance package.

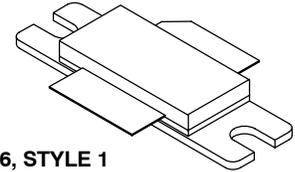
**The RF MOSFET Line**  
**RF Power Field Effect Transistors**  
**N-Channel Enhancement-Mode Lateral MOSFETs**

Designed for PCN and PCS base station applications with frequencies up to 1.9 to 2.0 GHz. Suitable for TDMA, CDMA and multicarrier amplifier applications.

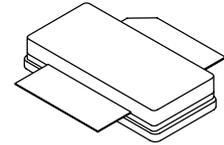
- Typical 2-Carrier N-CDMA Performance for  $V_{DD} = 28$  Volts,  $I_{DQ} = 850$  mA,  $f_1 = 1958.75$  MHz,  $f_2 = 1961.25$  MHz IS-95 CDMA (Pilot, Sync, Paging, Traffic Codes 8 Through 13) 1.2288 MHz Channel Bandwidth Carrier. Adjacent Channels Measured over a 30 kHz Bandwidth at  $f_1 - 885$  kHz and  $f_2 + 885$  kHz. Distortion Products Measured over 1.2288 MHz Bandwidth at  $f_1 - 2.5$  MHz and  $f_2 + 2.5$  MHz. Peak/Avg. = 9.8 dB @ 0.01% Probability on CCDF.  
 Output Power — 18 Watts Avg.  
 Power Gain — 14.5 dB  
 Efficiency — 25.8%  
 ACPR — -51 dB  
 IM3 — -37 dBc
- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 10:1 VSWR, @ 28 Vdc, 1960 MHz, 90 Watts CW Output Power
- Excellent Thermal Stability
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- Qualified Up to a Maximum of 32  $V_{DD}$  Operation
- Low Gold Plating Thickness on Leads. L Suffix Indicates 40 $\mu$ " Nominal.
- In Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 inch Reel.

**MRF5S19090LR3**  
**MRF5S19090LSR3**

**1990 MHz, 18 W AVG.,**  
**2 x N-CDMA, 28 V**  
**LATERAL N-CHANNEL**  
**RF POWER MOSFETs**



**CASE 465-06, STYLE 1**  
**NI-780**  
**MRF5S19090LR3**



**CASE 465A-06, STYLE 1**  
**NI-780S**  
**MRF5S19090LSR3**

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**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	Vdc
Gate-Source Voltage	$V_{GS}$	-0.5, +15	Vdc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25 $^\circ\text{C}$	$P_D$	261 1.49	Watts W/ $^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	- 65 to +200	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	200	$^\circ\text{C}$

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Value (1,2)	Unit
Thermal Resistance, Junction to Case Case Temperature 80 $^\circ\text{C}$ , 90 W CW Case Temperature 80 $^\circ\text{C}$ , 18 W CW	$R_{\theta JC}$	0.67 0.75	$^\circ\text{C}/\text{W}$

- (1) MTTF calculator available at <http://www.motorola.com/semiconductors/rf>. Select Tools/Software/Application Software/Calculators to access the MTTF calculators by product.
- (2) Refer to AN1955/D, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.motorola.com/semiconductors/rf>. Select Documentation/Application Notes - AN1955.

**NOTE - CAUTION** - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

**ESD PROTECTION CHARACTERISTICS**

Test Conditions	Class
Human Body Model	1 (Minimum)
Machine Model	M3 (Minimum)
Charge Device Model	C7 (Minimum)

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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**OFF CHARACTERISTICS**

Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 65\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ )	$I_{DSS}$	—	—	10	$\mu\text{A}$
Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 28\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ )	$I_{DSS}$	—	—	1	$\mu\text{A}$
Gate-Source Leakage Current ( $V_{GS} = 5\text{ Vdc}$ , $V_{DS} = 0\text{ Vdc}$ )	$I_{GSS}$	—	—	1	$\mu\text{A}$

**ON CHARACTERISTICS (DC)**

Gate Threshold Voltage ( $V_{DS} = 10\text{ Vdc}$ , $I_D = 200\ \mu\text{A}$ )	$V_{GS(th)}$	2.5	2.7	3.5	Vdc
Gate Quiescent Voltage ( $V_{DS} = 28\text{ Vdc}$ , $I_D = 850\text{ mA}$ )	$V_{GS(Q)}$	—	3.7	—	Vdc
Drain-Source On-Voltage ( $V_{GS} = 10\text{ Vdc}$ , $I_D = 2\text{ A}$ )	$V_{DS(on)}$	—	0.26	—	Vdc
Forward Transconductance ( $V_{DS} = 10\text{ Vdc}$ , $I_D = 2\text{ A}$ )	$g_{fs}$	—	5	—	S

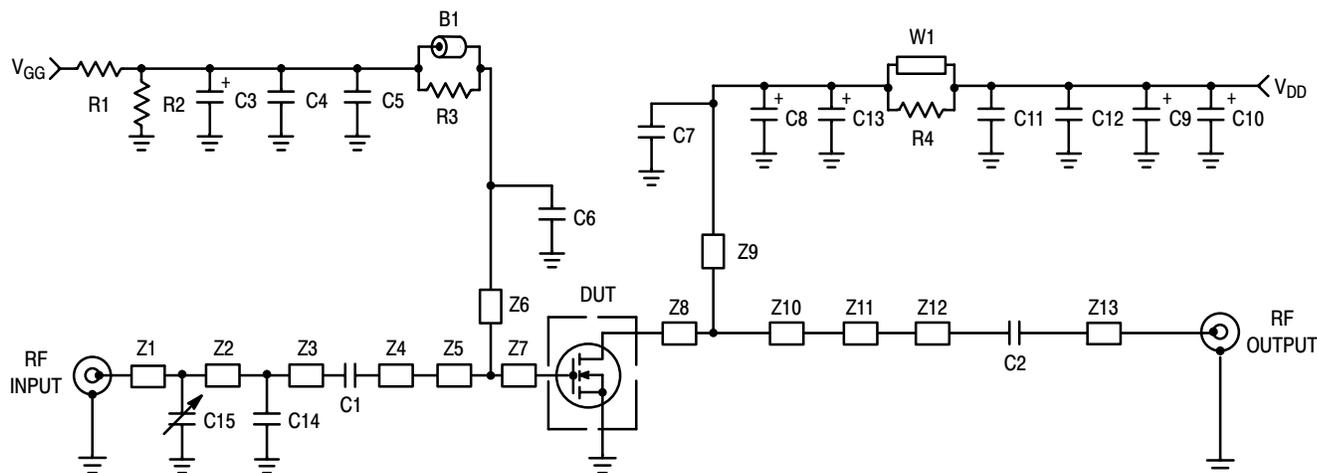
**DYNAMIC CHARACTERISTICS**

Reverse Transfer Capacitance (1) ( $V_{DS} = 28\text{ Vdc} \pm 30\text{ mV(rms)}$ ac @ 1 MHz, $V_{GS} = 0\text{ Vdc}$ )	$C_{rss}$	—	1.7	—	pF
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**FUNCTIONAL TESTS** (In Motorola Test Fixture, 50 ohm system) 2-Carrier N-CDMA, 1.2288 MHz Channel Bandwidth Carriers. ACPR measured in 30 kHz Bandwidth and IM3 measured in 1.2288 MHz Bandwidth. Peak/Avg. Ratio = 9.8 dB @ 0.01% Probability on CCDF.

Common-Source Amplifier Power Gain ( $V_{DD} = 28\text{ Vdc}$ , $P_{out} = 18\text{ W Avg.}$ , $I_{DQ} = 850\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ )	$G_{ps}$	13.5	14.5	—	dB
Drain Efficiency ( $V_{DD} = 28\text{ Vdc}$ , $P_{out} = 18\text{ W Avg.}$ , $I_{DQ} = 850\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ )	$\eta$	24	25.8	—	%
Third Order Intermodulation Distortion ( $V_{DD} = 28\text{ Vdc}$ , $P_{out} = 18\text{ W Avg.}$ , $I_{DQ} = 850\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ ); IM3 measured over 1.2288 MHz bandwidth at $f_1 = -2.5\text{ MHz}$ and $f_2 = +2.5\text{ MHz}$ )	IM3	—	-37	-35	dBc
Adjacent Channel Power Ratio ( $V_{DD} = 28\text{ Vdc}$ , $P_{out} = 18\text{ W Avg.}$ , $I_{DQ} = 850\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ ); ACPR measured over 30 kHz bandwidth at $f_1 = -885\text{ kHz}$ and $f_2 = +885\text{ kHz}$ )	ACPR	—	-51	-48	dBc
Input Return Loss ( $V_{DD} = 28\text{ Vdc}$ , $P_{out} = 18\text{ W Avg.}$ , $I_{DQ} = 850\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ )	IRL	—	-14.5	-9	dB

(1) Part is internally matched both on input and output.



Z1	0.140" x 0.080" Microstrip	Z8	0.091" x 1.133" Microstrip
Z2	0.450" x 0.080" Microstrip	Z9	0.542" x 0.071" Microstrip
Z3	0.140" x 0.080" Microstrip	Z10	0.450" x 1.133" Microstrip
Z4	0.525" x 0.080" Microstrip	Z11	0.640" x 0.141" Microstrip
Z5	0.636" x 0.141" Microstrip	Z12	0.316" x 0.080" Microstrip
Z6	0.340" x 0.050" Microstrip	Z13	1.209" x 0.080" Microstrip
Z7	0.320" x 1.401" Microstrip	PCB	Arlon GX-0300-55-22, 30 mil, $\epsilon_r = 2.55$

Figure 1. MRF5S19090 Test Circuit Schematic

Table 1. MRF5S19090 Test Circuit Component Designations and Values

Part	Description	Value, P/N or DWG	Manufacturer
B1	Short RF Bead	95F786	Newark
C1	22 pF Chip Capacitor, B Case	100B220CP 500X	ATC
C2	10 pF Chip Capacitor, B Case	100B100CP 500X	ATC
C3, C13	1 $\mu$ F, 50 V SMT Tantalum Capacitors	T494C105(1)050AS	Kemet
C4, C12	0.1 $\mu$ F Chip Capacitors, B Case	CDR33BX104AKWS	Kemet
C5, C11	1k pF Chip Capacitors, B Case	100B102JP 500X	ATC
C6, C7	4.3 pF Chip Capacitors, B Case	100B4R3JP 500X	ATC
C8	10 $\mu$ F, 35 V SMT Tantalum Capacitor	T494D106(1)035AS	Kemet
C9, C10	22 $\mu$ F, 35 V SMT Tantalum Capacitors	T494X226(1)035AS	Kemet
C14	2.7 pF Chip Capacitor, B Case	100B2.7BP 500X	ATC
C15	0.6 – 4.5 Gigatrim Variable Capacitor	44F3358	Newark
R1	1 k $\Omega$ Chip Resistor	D5534M07B1K00R	Newark
R2	560 k $\Omega$ Chip Resistor	CR1206 564JT	Newark
R3, R4	12 $\Omega$ Chip Resistors	RM73B2B120JT	Garrett Electronics
W1	1 turn 14 gauge wire		

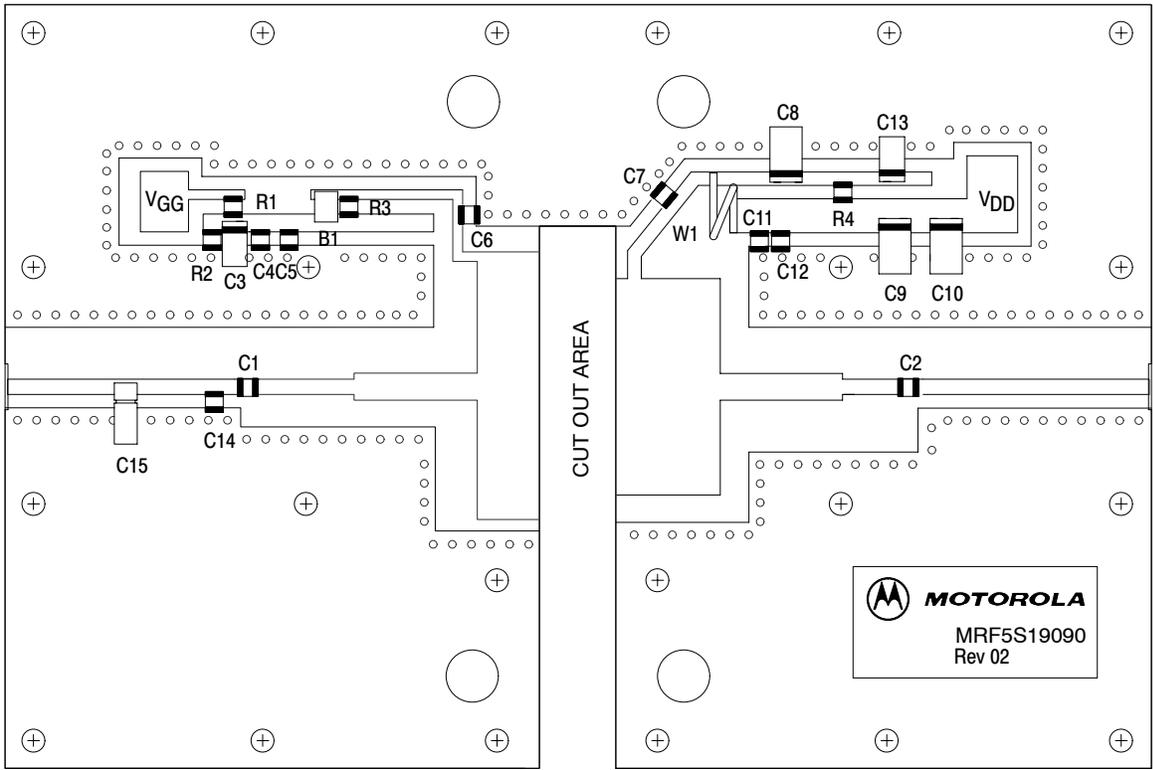


Figure 2. MRF5S19090 Test Circuit Component Layout

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## TYPICAL CHARACTERISTICS

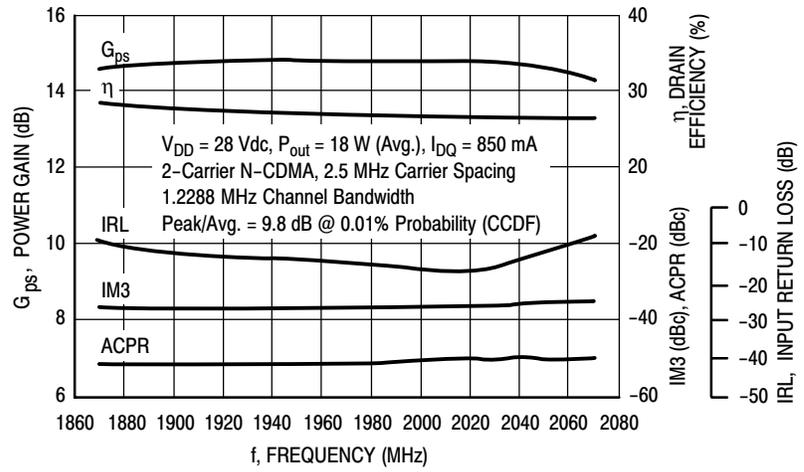


Figure 3. 2-Carrier N-CDMA Broadband Performance

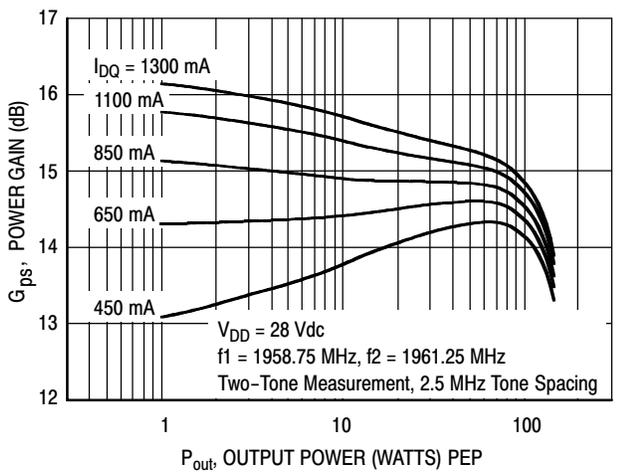


Figure 4. Two-Tone Power Gain versus Output Power

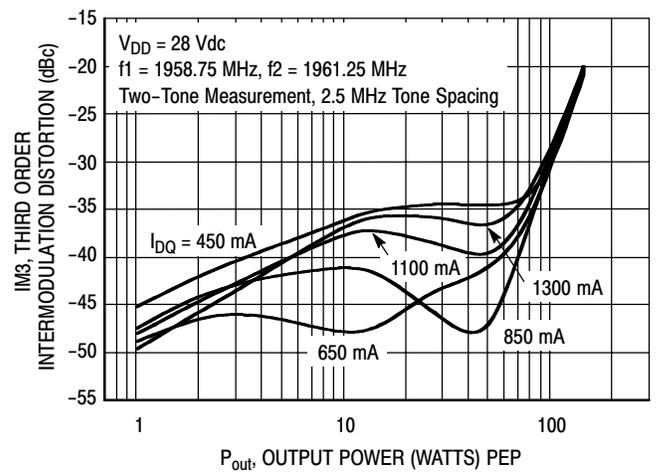


Figure 5. Third Order Intermodulation Distortion versus Output Power

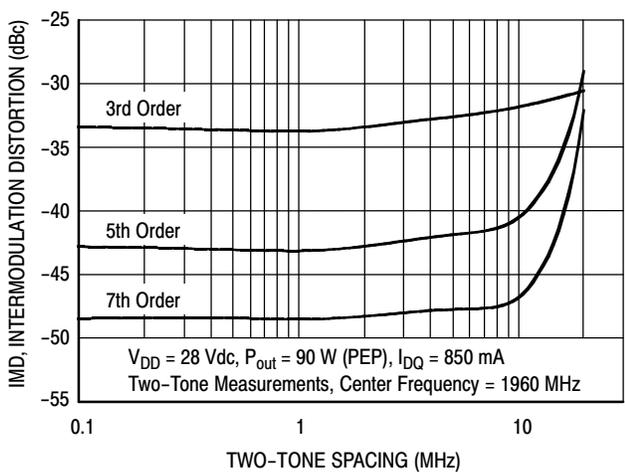


Figure 6. Intermodulation Distortion Products versus Tone Spacing

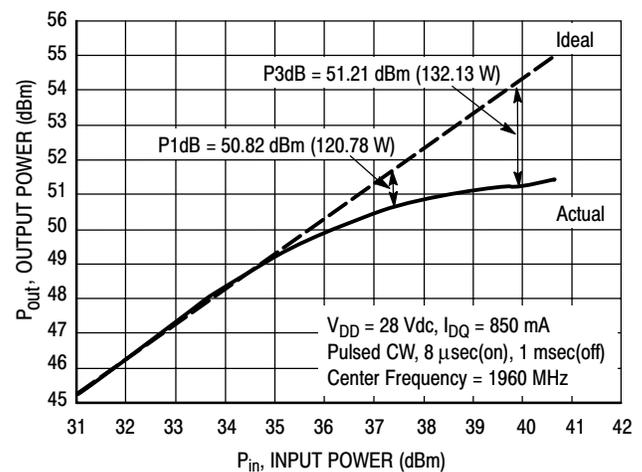
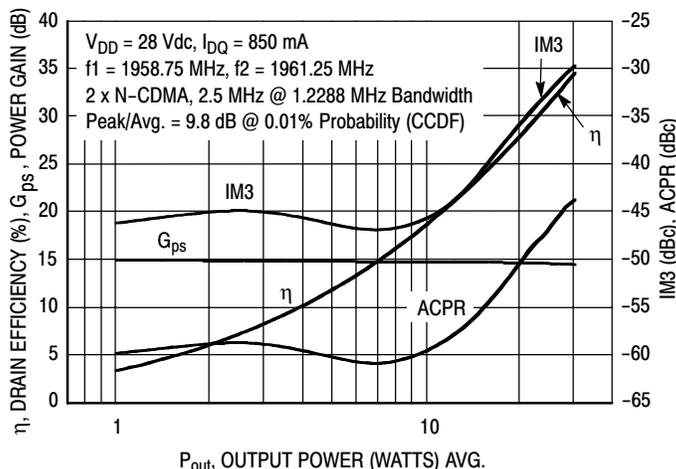


Figure 7. Pulse CW Output Power versus Input Power

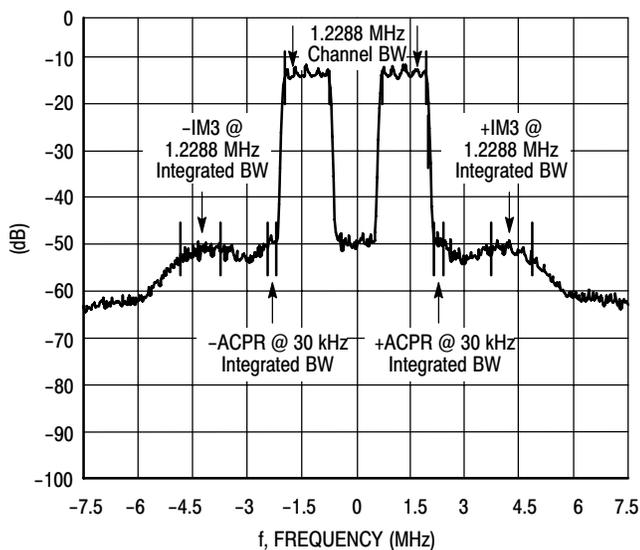
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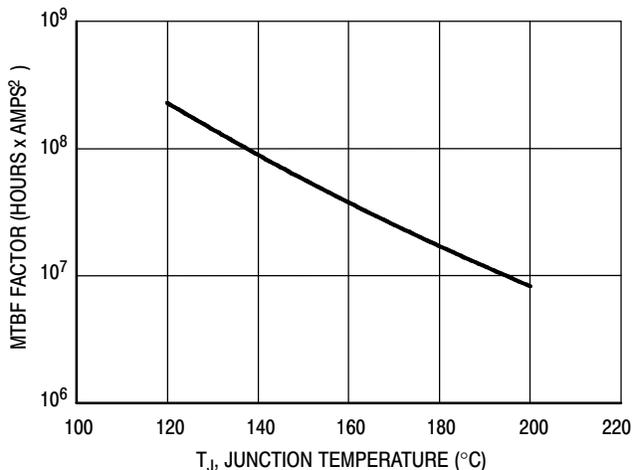
## TYPICAL CHARACTERISTICS



**Figure 8. 2-Carrier N-CDMA ACPR, IM3, Power Gain and Drain Efficiency versus Output Power**



**Figure 9. 2-Carrier N-CDMA Spectrum**

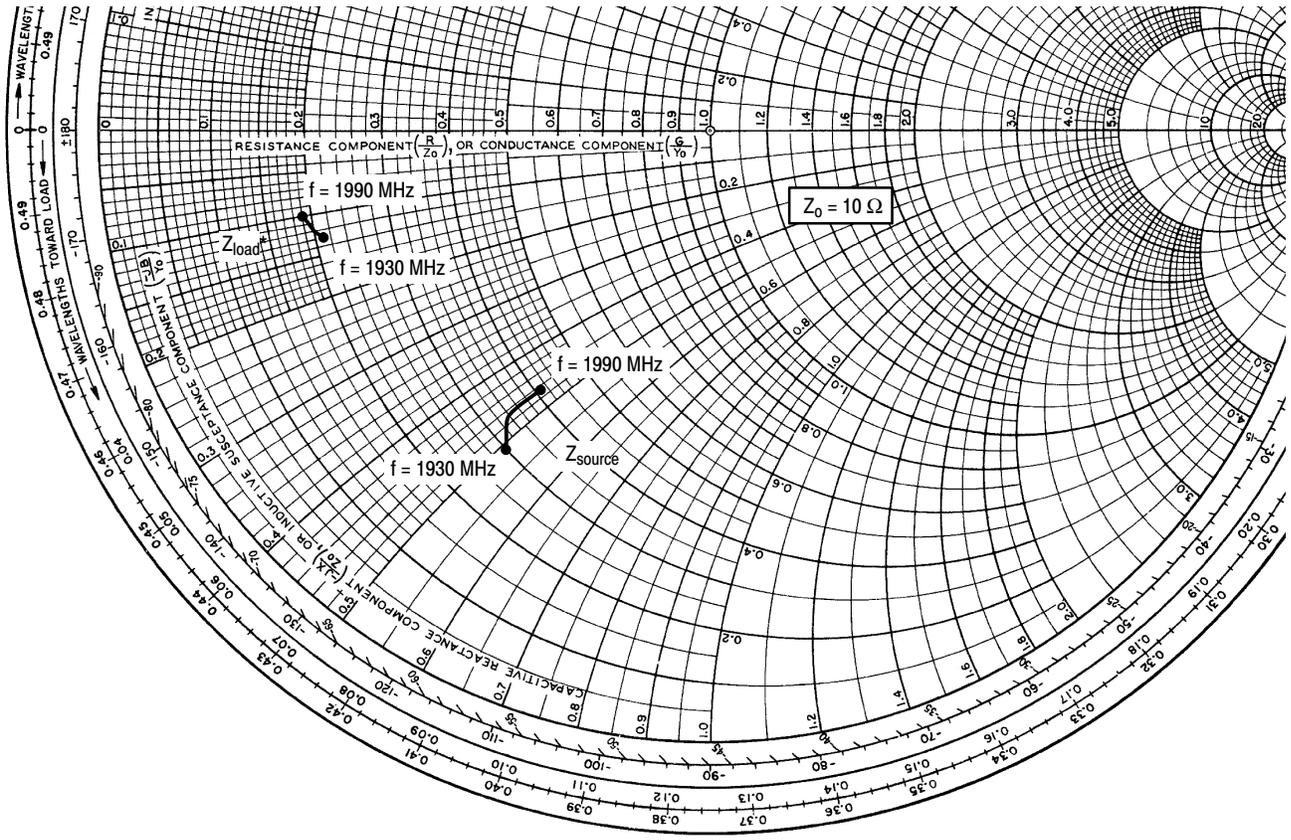


This above graph displays calculated MTBF in hours x ampere<sup>2</sup> drain current. Life tests at elevated temperatures have correlated to better than  $\pm 10\%$  of the theoretical prediction for metal failure. Divide MTBF factor by  $I_D^2$  for MTBF in a particular application.

**Figure 10. MTBF Factor versus Junction Temperature**

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$V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 850\text{ mA}$ ,  $P_{out} = 18\text{ W Avg.}$

f MHz	$Z_{source}$ $\Omega$	$Z_{load}$ $\Omega$
1930	$2.98 - j5.12$	$2.07 - j1.31$
1960	$3.36 - j4.65$	$2.02 - j1.18$
1990	$4.06 - j4.64$	$1.93 - j1.01$

$Z_{source}$  = Test circuit impedance as measured from gate to ground.

$Z_{load}$  = Test circuit impedance as measured from drain to ground.

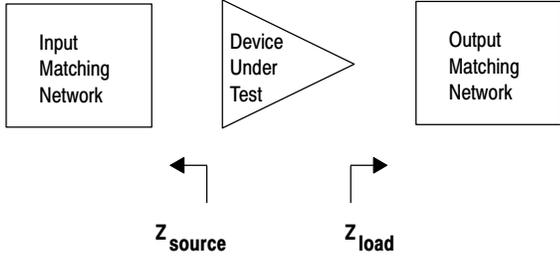


Figure 11. Series Equivalent Input and Output Impedance



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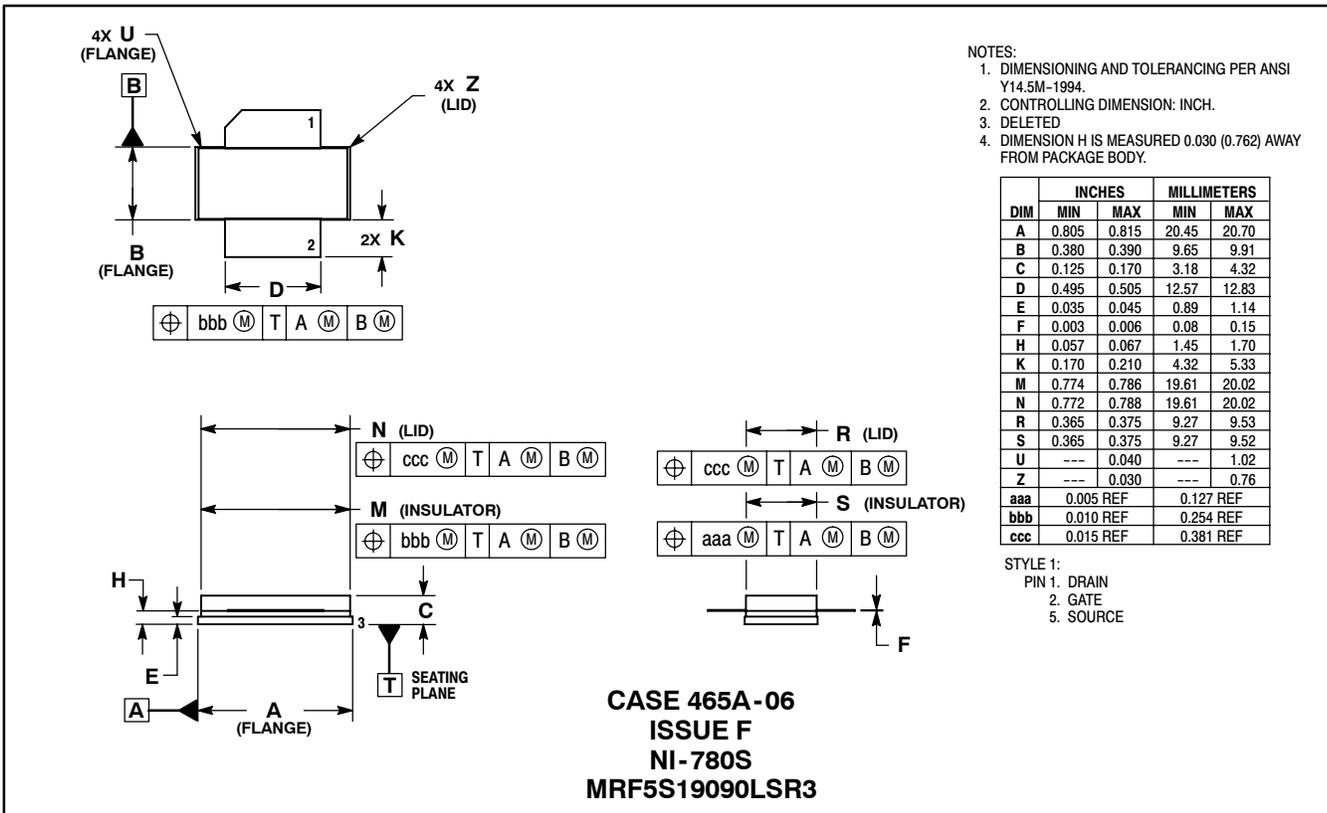
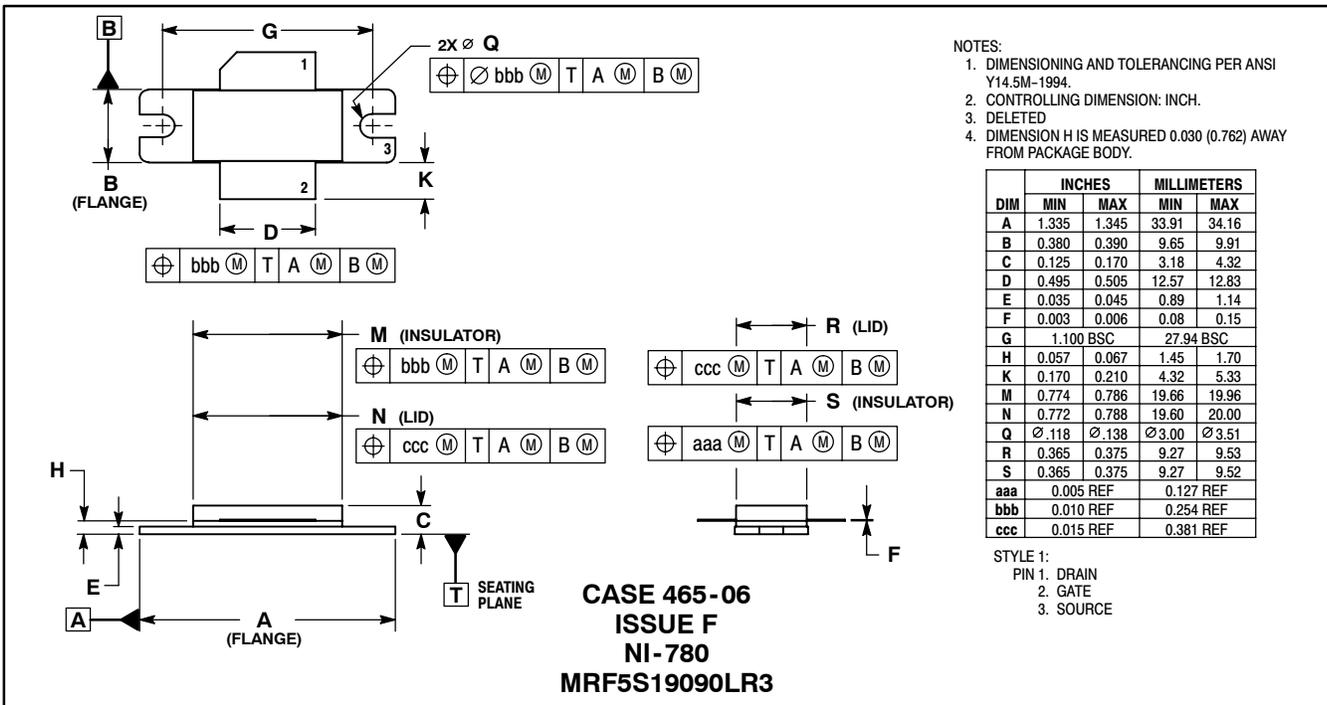


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